



## News Release

### **Unisem (M) Berhad ("Unisem") received Supplier of the Year 2006 Award from Sirenza Microdevices, Inc.**

**Kuala Lumpur, 7 August 2007** – Unisem received the "Supplier of the Year 2006 Award" from its valued customer Sirenza Microdevices, Inc. ("Sirenza"), a supplier of radio frequency (RF) components. This award recognizes excellence in performance, yield, cycle time, responsiveness and cost of ownership.

Presenting the award to Unisem was Mr Kin Tan, Vice President of Operation of Sirenza, "We appreciate the support of the Unisem team for consistent delivery to Sirenza's expectation," said Mr Kin Tan.

Receiving the award, Unisem's Executive Director/Group Chief Operating Officer, Mr CH Ang commented, "We are very proud and honor to receive such award and recognition from Sirenza for 2 years consecutively. We will continue to deliver consistent quality service and cycle time to our customer."

#### **About Sirenza [www.sirenza.com](http://www.sirenza.com)**

Sirenza Microdevices is a supplier of radio frequency (RF) components. Headquartered in Broomfield, Colorado, with operations in China, Germany and the U.S., Sirenza and its subsidiary, Premier Devices design and develop RF components for the commercial communications, consumer, and aerospace, defense and homeland security (A&D) equipment markets. Sirenza's integrated circuit (IC), multi-chip module (MCM) and passive product lines include amplifiers, power amplifiers, cable TV amplifiers, circulators, isolators, mixers, splitters, transformers, couplers, modulators, demodulators, transceivers, tuners, discrete devices, signal source components, government and military specified components, and antennae and receivers for satellite radio. Certifications include ISO 9001:2000 Quality Management System and ISO 14001:2004 Environmental Management System (registered by QMI).

#### **About Unisem [www.unisem.com.my](http://www.unisem.com.my)**

Unisem (M) Berhad, a leading semiconductor packaging and test services company in Malaysia, has its main packaging and testing facilities in Ipoh, Malaysia with additional packaging and testing facilities in Wales, United Kingdom, Chengdu, PRC, Batam, Indonesia, and in Sunnyvale, California, USA. Unisem offers an integrated suite of packaging and test services for semiconductor companies such as wafer probe, a wide range of leadframe and substrate IC packaging, high-end RF and mix-signal test, tape & reel and drop-shipment services.

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